



GooLED-16080 Pin Fin Heat Sink Φ160mm

Features VS Benefits

- * Mechanical compatibility with direct mounting of the LED modules to the LED cooler thermal performance matching the lumen packages.
- * For spotlight and downlight designs from 4,000 to 9,500 lumen.
- * Thermal resistance range Rth 0.76°C/W.
- * Modular design with mounting holes foreseen for direct mounting of a wide range of LED modules and COB's:
- * Diameter 160mm Standard height 80.0mm, Other heights on request.
- * Forged from highly conductive aluminum.
- * With the SMD products (3030 , 2835 , 5050......) and modules: Bridgelux ,Cree ,Citizen ,Edison , GE lighting, LG Innotek ,Lumileds ,Lumens ,Luminus ,Nichia ,Osram ,Philips ,Prolight Opto, Samsung ,Seoul ,Tridonic ,Vossloh-Schwabe ,Xicato.













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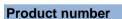
ProLight Opto











Example:GooLED-16080-B



B-Black

C-Clear

Z-Custom

01) Bridelux: Vero 18/22 Vero SE 18/29 LED engines;

02) Cree: XLamp CXA 25xx, Xlamp CXB 25xx, CXA 30xx, Xlamp CXB 30xx LED engines;

03) Citizen: CLU036, CLU038, CLU721, CLU711, CLU046, CLU048, CLU731 LED engines;

04) Edison: EdiLex III COB LED engines;

05) GE lighting: Infusion™ LED engines;

06) LG Innotek: 32W, 42W, 56W LED engines;

07) LumiLEDS: LUXEON 1211, LUXEON 1216, LUXEON 1812, LUXEON 1825 LED engines;

08) Lumens: Ergon-COB-2530, 2540, 3050, 3070 LED engines;

09) Luminus: CXM-18, CLM-22, CXM-22 LED engines;

10) Nichia: NFCWL036B, NFCLL036B, NFCWL060B, NFCLL060B LED engines;

11) Osram: SOLERIQ® S 19, Core series LED engines;

12) Philips: Fortimo SLM LED engines;

16) Prolight Opto: PABS, PABA, PACB, PANA LED engines;

13) Samsung: LC026B, LC033B, LC040B, LC040D, LC060D, LC080D LED engines;

14) Seoul Semiconductor: Acrich MJT COBs, DC COB LED engines;

15) Tridonic: SLE G6 19mm, SLE G6 23mm LED engines;

17) Vossloh-Schwabe: LUGA Shop and LUGA C LED engines;

18) Xicato: XSM, XIM,XTM LED engines;

- Mentioned models are an extraction of full product range.
- For specific mechanical adaptations please contact MingfaTech.
- MingfaTech reserves the right to change products or specifications without prior notice.



Http://www.mingfatech.com





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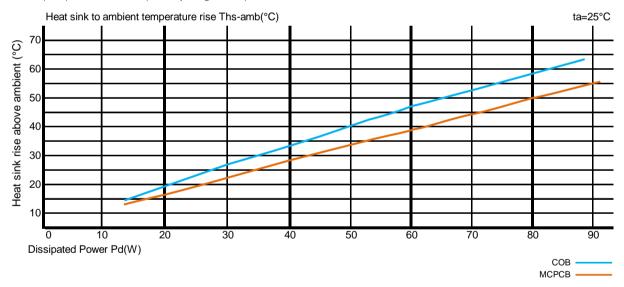
The Heatsink deta table



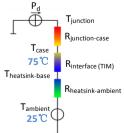
Model No.	GooLED-16080
Heatsink Size	Ф160xH80mm
Heatsink Material	AL1070
Finish	Black Anodized
Weight (g)	1190.0
Dissipated power (Ths-amb,50℃)	65.0 (W)
Cooling surface area (mm²)	225323
Thermal Resistance (Rhs-amb)	0.76 (°C/W)

The thermal data table

- * Please be aware the dissipated power Pd is not the same as the electrical power Pe of a LED module.
- *To calculate the dissipated power please use the following formula: $Pd = Pe \times (1-\eta L)$.
- Pd Dissipated power; Pe Electrical power; $\eta L = \text{Light effciency of the LED module}$;



*The aluminum substrate side of the package outer shell is thermally connected to the heat sink via TIM (Thermal interface material). MingFa recommends the use of a high thermal conductive interface between the LED module and the LED cooler. Either thermal grease, A thermal pad or a phase change thermal pad thickness 0.1-0.15mm is recommended.



- *Thermal resistance is a heat property and a measurement of a temperature difference by which an object or material resists a heat flow. Geometric shapes are different, the thermal resistance is different. Formula: $\theta = (Ths Ta)/Pd$
- θ Thermal Resistance [°C/W] ; Ths - Heatsink temperature ; Ta - Ambient temperature ;
- *The thermal resistance between the junction section of the light-emitting diode and the aluminum substrate side of the package outer shell is $R_{\text{junction-case}}$, the thermal resistance of the TIM outside the package is $R_{\text{interface}}$ (TIM), [°C/W], the thermal resistance with the heat sink is $R_{\text{heatsink-ambient}}$ [°C/W], and the ambient temperature is T_{ambient} [°C].
- *Thermal resistances outside the package $R_{interface\,(TIM)}$ and $R_{heatsink-ambient}$ can be integrated into the thermal resistance $R_{case-ambient}$ at this point. Thus, the following formula is also used:

 $T_{junction} = (R_{junction-case} + R_{case-ambient}) \cdot Pd + T_{ambient}$

